

Device Overview

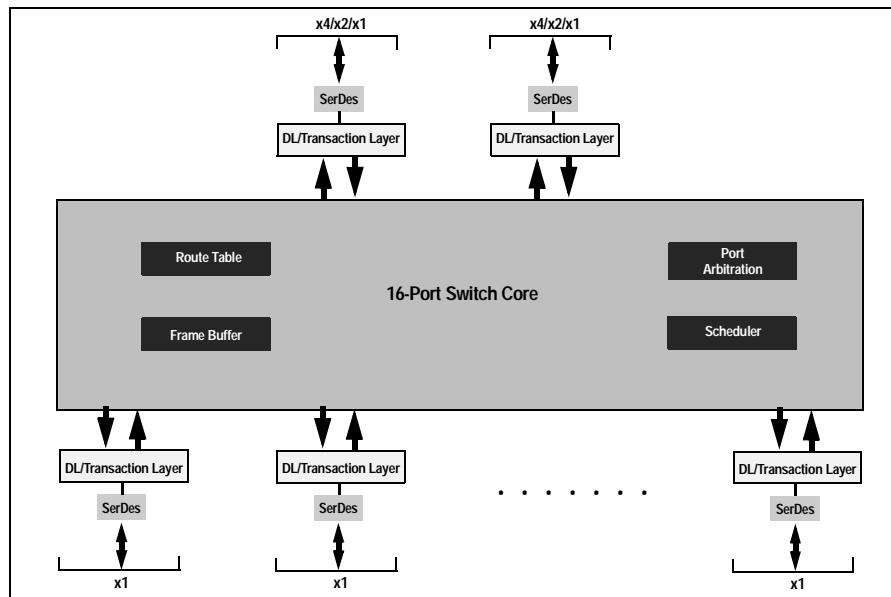
The 89HPES22H16 is a member of the IDT PRECISE™ family of PCI Express® switching solutions. The PES22H16 is a 22-lane, 16-port peripheral chip that performs PCI Express packet switching with a feature set optimized for high-performance applications such as servers, storage, and communications/networking. It provides connectivity and switching functions between a PCI Express upstream port and up to fifteen downstream ports and supports switching between downstream ports.

Features

- ◆ **High Performance PCI Express Switch**
  - Sixteen maximum switch ports
    - Two x4 ports
    - Fourteen x1 ports
  - Twenty-two 2.5 Gbps embedded SerDes
  - Supports pre-emphasis and receive equalization on per-port basis
  - Delivers 88 Gbps (11 GBps) of aggregate switching capacity
  - Low-latency cut-through switch architecture
  - Support for Max Payload Size up to 2048 bytes
  - Supports two virtual channels and eight traffic classes
  - PCI Express Base Specification Revision 1.1 compliant

- ◆ **Flexible Architecture with Numerous Configuration Options**
  - Port arbitration schemes utilizing round robin algorithms
  - Automatic per port link width negotiation from x4 to x2 or x1
  - Automatic lane reversal on all ports
  - Automatic polarity inversion on all lanes
  - Supports locked transactions, allowing use with legacy software
  - Ability to load device configuration from serial EEPROM
  - Ability to control device via SMBus
- ◆ **Highly Integrated Solution**
  - Requires no external components
  - Incorporates on-chip internal memory for packet buffering and queueing
  - Integrates twenty-two 2.5 Gbps embedded full duplex SerDes, 8B/10B encoder/decoder (no separate transceivers needed)
- ◆ **Reliability, Availability, and Serviceability (RAS) Features**
  - Redundant upstream port failover capability
  - Supports optional PCI Express end-to-end CRC checking

Block Diagram



22 PCI Express Lanes  
2 x4 ports and 14 x1 Ports

Figure 1 Internal Block Diagram

- Internal end-to-end parity protection on all TLPs ensures data integrity even in systems that do not implement end-to-end CRC (ECRC)
- Supports optional PCI Express Advanced Error Reporting
- Supports PCI Express Hot-Plug
  - Compatible with Hot-Plug I/O expanders used on PC motherboards
- Supports Hot-Swap
- ◆ **Power Management**
  - Supports PCI Power Management Interface specification, Revision 1.1 (PCI-PM)
    - Supports powerdown modes at the link level (L0, L0s, L1, L2/L3 Ready and L3) and at the device level (D0, D3<sub>hot</sub>)
  - Unused SerDes disabled
- ◆ **Testability and Debug Features**
  - Built in SerDes Pseudo-Random Bit Stream (PRBS) generator
  - Ability to read and write any internal register via the SMBus
  - Ability to bypass link training and force any link into any mode
  - Provides statistics and performance counters
- ◆ **Thirty-two General Purpose Input/Output pins**
  - Each pin may be individually configured as an input or output
  - Each pin may be individually configured as an interrupt input
  - Some pins have selectable alternate functions
- ◆ **Packaged in a 23mm x 23mm 484-ball Flip Chip BGA with 1mm ball spacing**

Product Description

Utilizing standard PCI Express interconnect, the PES22H16 provides the most efficient I/O connectivity for applications requiring high throughput, low latency, and simple board layout with a minimum number of board layers. It provides 88 Gbps of aggregated, full-duplex switching capacity through 22 integrated serial lanes, using proven and robust IDT technology. Each lane provides 2.5 Gbps of bandwidth in both directions and is fully compliant with PCI Express Base specification 1.1.

The PES22H16 is based on a flexible and efficient layered architecture. The PCI Express layer consists of SerDes, Physical, Data Link and Transaction layers. The PES22H16 can operate either as a store and forward switch or a cut-through switch and is designed to switch memory and I/O transactions. It supports eight Traffic Classes (TCs) and two Virtual Channels (VCs) with sophisticated resource management to enable efficient switching and I/O connectivity.

SMBus Interface

The PES22H16 contains two SMBus interfaces. The slave interface provides full access to the configuration registers in the PES22H16, allowing every configuration register in the device to be read or written by an external agent. The master interface allows the default configuration register values of the PES22H16 to be overridden following a reset with values programmed in an external serial EEPROM. The master interface is also used by an external Hot-Plug I/O expander.

Six pins make up each of the two SMBus interfaces. These pins consist of an SMBus clock pin, an SMBus data pin, and 4 SMBus address pins. In the slave interface, these address pins allow the SMBus address to which the device responds to be configured. In the master interface, these address pins allow the SMBus address of the serial configuration EEPROM from which data is loaded to be configured. The SMBus address is set up on negation of PERSTN by sampling the corresponding address pins. When the pins are sampled, the resulting address is assigned as shown in Table 1.

Bit	Slave SMBus Address	Master SMBus Address
1	SSMBADDR[1]	MSMBADDR[1]
2	SSMBADDR[2]	MSMBADDR[2]
3	SSMBADDR[3]	MSMBADDR[3]
4	0	MSMBADDR[4]
5	SSMBADDR[5]	1
6	1	0
7	1	1

Table 1 Master and Slave SMBus Address Assignment

As shown in Figure 3, the master and slave SMBuses may be used in a unified or split configuration. In the unified configuration, shown in Figure 3(a), the master and slave SMBuses are tied together and the PES22H16 acts both as a SMBus master as well as a SMBus slave on this bus. This requires that the SMBus master or processor that has access to PES22H16 registers supports SMBus arbitration. In some systems, this SMBus master interface may be implemented using general purpose I/O pins on a processor or micro controller, and may not support SMBus arbitration. To support these systems, the PES22H16 may be configured to operate in a split configuration as shown in Figure 3(b).

In the split configuration, the master and slave SMBuses operate as two independent buses and thus multi-master arbitration is never required. The PES22H16 supports reading and writing of the serial EEPROM on the master SMBus via the slave SMBus, allowing in system programming of the serial EEPROM.

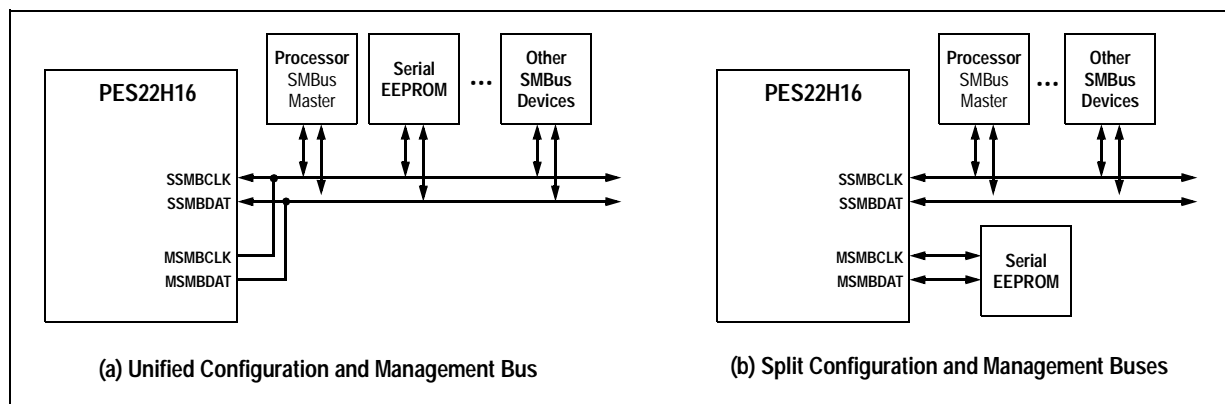


Figure 3 SMBus Interface Configuration Examples

### Hot-Plug Interface

The PES22H16 supports PCI Express Hot-Plug on each downstream port (ports 1 through 15). To reduce the number of pins required on the device, the PES22H16 utilizes an external I/O expander, such as that used on PC motherboards, connected to the SMBus master interface. Following reset and configuration, whenever the state of a Hot-Plug output needs to be modified, the PES22H16 generates an SMBus transaction to the I/O expander with the new value of all of the outputs. Whenever a Hot-Plug input changes, the I/O expander generates an interrupt which is received on the IOEXPINTN input pin (alternate function of GPIO) of the PES22H16. In response to an I/O expander interrupt, the PES22H16 generates an SMBus transaction to read the state of all of the Hot-Plug inputs from the I/O expander.

### General Purpose Input/Output

The PES22H16 provides 32 General Purpose I/O (GPIO) pins that may be individually configured as general purpose inputs, general purpose outputs, or alternate functions. Some GPIO pins are shared with other on-chip functions. These alternate functions may be enabled via software, SMBus slave interface, or serial configuration EEPROM.

### Pin Description

The following tables lists the functions of the pins provided on the PES22H16. Some of the functions listed may be multiplexed onto the same pin. The active polarity of a signal is defined using a suffix. Signals ending with an "N" are defined as being active, or asserted, when at a logic zero (low) level. All other signals (including clocks, buses, and select lines) will be interpreted as being active, or asserted, when at a logic one (high) level. Differential signals end with a suffix "N" or "P." The differential signal ending in "P" is the positive portion of the differential pair and the differential signal ending in "N" is the negative portion of the differential pair.

Signal	Type	Name/Description
PE0RP[3:0] PE0RN[3:0]	I	<b>PCI Express Port 0 Serial Data Receive.</b> Differential PCI Express receive pairs for port 0. Port 0 is the upstream port.
PE0TP[3:0] PE0TN[3:0]	O	<b>PCI Express Port 0 Serial Data Transmit.</b> Differential PCI Express transmit pairs for port 0. Port 0 is the upstream port.
PE1RP[0] PE1RN[0]	I	<b>PCI Express Port 1 Serial Data Receive.</b> Differential PCI Express receive pair for port 1.
PE1TP[0] PE1TN[0]	O	<b>PCI Express Port 1 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 1.
PE2RP[3:0] PE2RN[3:0]	I	<b>PCI Express Port 2 Serial Data Receive.</b> Differential PCI Express receive pairs for port 2.
PE2TP[3:0] PE2TN[3:0]	O	<b>PCI Express Port 2 Serial Data Transmit.</b> Differential PCI Express transmit pairs for port 2.

Table 2 PCI Express Interface Pins (Part 1 of 3)

Signal	Type	Name/Description
PE3RP[0] PE3RN[0]	I	<b>PCI Express Port 3 Serial Data Receive.</b> Differential PCI Express receive pair for port 3.
PE3TP[0] PE3TN[0]	O	<b>PCI Express Port 3 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 3.
PE4RP[0] PE4RN[0]	I	<b>PCI Express Port 4 Serial Data Receive.</b> Differential PCI Express receive pair for port 4.
PE4TP[0] PE4TN[0]	O	<b>PCI Express Port 4 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 4.
PE5RP[0] PE5RN[0]	I	<b>PCI Express Port 5 Serial Data Receive.</b> Differential PCI Express receive pair for port 5.
PE5TP[0] PE5TN[0]	O	<b>PCI Express Port 5 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 5.
PE6RP[0] PE6RN[0]	I	<b>PCI Express Port 6 Serial Data Receive.</b> Differential PCI Express receive pair for port 6.
PE6TP[0] PE6TN[0]	O	<b>PCI Express Port 6 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 6.
PE7RP[0] PE7RN[0]	I	<b>PCI Express Port 7 Serial Data Receive.</b> Differential PCI Express receive pair for port 7.
PE7TP[0] PE7TN[0]	O	<b>PCI Express Port 7 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 7.
PE8RP[0] PE8RN[0]	I	<b>PCI Express Port 8 Serial Data Receive.</b> Differential PCI Express receive pair for port 8.
PE8TP[0] PE8TN[0]	O	<b>PCI Express Port 8 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 8.
PE9RP[0] PE9RN[0]	I	<b>PCI Express Port 9 Serial Data Receive.</b> Differential PCI Express receive pair for port 9.
PE9TP[0] PE9TN[0]	O	<b>PCI Express Port 9 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 9.
PE10RP[0] PE10RN[0]	I	<b>PCI Express Port 10 Serial Data Receive.</b> Differential PCI Express receive pair for port 10.
PE10TP[0] PE10TN[0]	O	<b>PCI Express Port 10 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 10.
PE11RP[0] PE11RN[0]	I	<b>PCI Express Port 11 Serial Data Receive.</b> Differential PCI Express receive pair for port 11.
PE11TP[0] PE11TN[0]	O	<b>PCI Express Port 11 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 11.
PE12RP[0] PE12RN[0]	I	<b>PCI Express Port 12 Serial Data Receive.</b> Differential PCI Express receive pair for port 12.
PE12TP[0] PE12TN[0]	O	<b>PCI Express Port 12 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 12.
PE13RP[0] PE13RN[0]	I	<b>PCI Express Port 13 Serial Data Receive.</b> Differential PCI Express receive pair for port 13.
PE13TP[0] PE13TN[0]	O	<b>PCI Express Port 13 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 13. W

Table 2 PCI Express Interface Pins (Part 2 of 3)

Signal	Type	Name/Description
PE14RP[0] PE14RN[0]	I	<b>PCI Express Port 14 Serial Data Receive.</b> Differential PCI Express receive pair for port 14.
PE14TP[0] PE14TN[0]	O	<b>PCI Express Port 14 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 14.
PE15RP[0] PE15RN[0]	I	<b>PCI Express Port 15 Serial Data Receive.</b> Differential PCI Express receive pair for port 15.
PE15TP[0] PE15TN[0]	O	<b>PCI Express Port 15 Serial Data Transmit.</b> Differential PCI Express transmit pair for port 15.
REFCLKM	I	<b>PCI Express Reference Clock Mode Select.</b> This signal selects the frequency of the reference clock input. 0x0 - 100 MHz 0x1 - 125 MHz
PEREFCLKP[3:0] PEREFCLKN[3:0]	I	<b>PCI Express Reference Clock.</b> Differential reference clock pair input. This clock is used as the reference clock by on-chip PLLs to generate the clocks required for the system logic and on-chip SerDes. The frequency of the differential reference clock is determined by the REFCLKM signal.

Table 2 PCI Express Interface Pins (Part 3 of 3)

Signal	Type	Name/Description
MSMBADDR[4:1]	I	<b>Master SMBus Address.</b> These pins determine the SMBus address of the serial EEPROM from which configuration information is loaded.
MSMBCLK	I/O	<b>Master SMBus Clock.</b> This bidirectional signal is used to synchronize transfers on the master SMBus. It is active and generating the clock only when the EEPROM or I/O Expanders are being accessed.
MSMBDAT	I/O	<b>Master SMBus Data.</b> This bidirectional signal is used for data on the master SMBus.
SSMBADDR[5,3:1]	I	<b>Slave SMBus Address.</b> These pins determine the SMBus address to which the slave SMBus interface responds.
SSMBCLK	I/O	<b>Slave SMBus Clock.</b> This bidirectional signal is used to synchronize transfers on the slave SMBus.
SSMBDAT	I/O	<b>Slave SMBus Data.</b> This bidirectional signal is used for data on the slave SMBus.

Table 3 SMBus Interface Pins

Signal	Type	Name/Description
GPIO[0]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin.
GPIO[1]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin.
GPIO[2]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin.
GPIO[3]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin.

Table 4 General Purpose I/O Pins (Part 1 of 4)

Signal	Type	Name/Description
GPIO[4]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin.
GPIO[5]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: GPEN Alternate function pin type: Output Alternate function: General Purpose Event (GPE) output
GPIO[6]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P1RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 1
GPIO[7]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P2RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 2
GPIO[8]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P3RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 3
GPIO[9]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P4RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 4
GPIO[10]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P5RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 5
GPIO[11]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P6RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 6
GPIO[12]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P7RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 7
GPIO[13]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P8RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 8

Table 4 General Purpose I/O Pins (Part 2 of 4)

Signal	Type	Name/Description
GPIO[14]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P9RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 9
GPIO[15]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P10RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 10
GPIO[16]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P11RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 11
GPIO[17]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P12RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 12
GPIO[18]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P13RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 13
GPIO[19]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P14RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 14
GPIO[20]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: P15RSTN Alternate function pin type: Output Alternate function: Reset output for downstream port 15
GPIO[21]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN0 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 0
GPIO[22] <sup>1</sup>	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN1 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 1
GPIO[23]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN2 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 2

Table 4 General Purpose I/O Pins (Part 3 of 4)

Signal	Type	Name/Description
GPIO[24]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN3 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 3
GPIO[25] <sup>1</sup>	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN4 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 4
GPIO[26]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN5 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 5
GPIO[27]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN6 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 6
GPIO[28]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN7 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 7
GPIO[29]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin.
GPIO[30]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin.
GPIO[31]	I/O	General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: IOEXPINTN10 Alternate function pin type: Input Alternate function: SMBus I/O expander interrupt 10

Table 4 General Purpose I/O Pins (Part 4 of 4)

<sup>1</sup> GPIO pins 22 and 25 are not available in the 23x23mm package.

Signal	Type	Name/Description
CCLKDS	I	<b>Common Clock Downstream.</b> When the CCLKDS pin is asserted, it indicates that a common clock is being used between the downstream device and the downstream port.
CCLKUS	I	<b>Common Clock Upstream.</b> When the CCLKUS pin is asserted, it indicates that a common clock is being used between the upstream device and the upstream port.
MSMBSMODE	I	<b>Master SMBus Slow Mode.</b> The assertion of this pin indicates that the master SMBus should operate at 100 KHz instead of 400 KHz. This value may not be overridden.

Table 5 System Pins (Part 1 of 2)



Signal	Type	Name/Description
PERSTN	I	<b>Fundamental Reset.</b> Assertion of this signal resets all logic inside the PES22H16 and initiates a PCI Express fundamental reset.
RSTHALT	I	<b>Reset Halt.</b> When this signal is asserted during a PCI Express fundamental reset, the PES22H16 executes the reset procedure and remains in a reset state with the Master and Slave SMBuses active. This allows software to read and write registers internal to the device before normal device operation begins. The device exits the reset state when the RSTHALT bit is cleared in the PA_SWCTL register by an SMBus master.
SWMODE[3:0]	I	<b>Switch Mode.</b> These configuration pins determine the PES22H16 switch operating mode. These pins should be static and not change following the negation of PERSTN. 0x0 - Normal switch mode 0x1 - Normal switch mode with Serial EEPROM initialization 0x2 through 0x7 - Reserved 0x8 - Normal switch mode with upstream port failover (port 0 selected as the upstream port) 0x9 - Normal switch mode with upstream port failover (port 2 selected as the upstream port) 0xA - Normal switch mode with Serial EEPROM initialization and upstream port failover (port 0 selected as the upstream port) 0xB - Normal switch mode with Serial EEPROM initialization and upstream port failover (port 2 selected as the upstream port) 0xC through 0xF - Reserved

Table 5 System Pins (Part 2 of 2)

Signal	Type	Name/Description
JTAG_TCK	I	<b>JTAG Clock.</b> This is an input test clock used to clock the shifting of data into or out of the boundary scan logic or JTAG Controller. JTAG_TCK is independent of the system clock with a nominal 50% duty cycle.
JTAG_TDI	I	<b>JTAG Data Input.</b> This is the serial data input to the boundary scan logic or JTAG Controller.
JTAG_TDO	O	<b>JTAG Data Output.</b> This is the serial data shifted out from the boundary scan logic or JTAG Controller. When no data is being shifted out, this signal is tri-stated.
JTAG_TMS	I	<b>JTAG Mode.</b> The value on this signal controls the test mode select of the boundary scan logic or JTAG Controller.
JTAG_TRST_N	I	<b>JTAG Reset.</b> This active low signal asynchronously resets the boundary scan logic and JTAG TAP Controller. An external pull-up on the board is recommended to meet the JTAG specification in cases where the tester can access this signal. However, for systems running in functional mode, one of the following should occur: 1) actively drive this signal low with control logic 2) statically drive this signal low with an external pull-down on the board

Table 6 Test Pins

Signal	Type	Name/Description
V <sub>DD</sub> CORE	I	<b>Core VDD.</b> Power supply for core logic.
V <sub>DD</sub> I/O	I	<b>I/O VDD.</b> LVTTTL I/O buffer power supply.
V <sub>DD</sub> PE	I	<b>PCI Express Digital Power.</b> PCI Express digital power used by the digital power of the SerDes.

Table 7 Power and Ground Pins

Signal	Type	Name/Description
$V_{DDAPE}$	I	<b>PCI Express Analog Power.</b> PCI Express analog power used by the PLL and bias generator.
$V_{SS}$	I	Ground.
$V_{TTPE}$		<b>PCI Express Serial Data Transmit Termination Voltage.</b> This pin allows the driver termination voltage to be set, enabling the system designer to control the Common Mode Voltage and output voltage swing of the corresponding PCI Serial Data Transmit differential pair.

Table 7 Power and Ground Pins

## Pin Characteristics

**Note:** Some input pads of the PES22H16 do not contain internal pull-ups or pull-downs. Unused inputs should be tied off to appropriate levels. This is especially critical for unused control signal inputs which, if left floating, could adversely affect operation. Also, any input pin left floating can cause a slight increase in power consumption.

Function	Pin Name	Type	Buffer	I/O Type	Internal Resistor	Notes
PCI Express Interface	PE0RN[3:0]	I	CML	Serial Link		
	PE0RP[3:0]	I				
	PE0TN[3:0]	O				
	PE0TP[3:0]	O				
	PE1RN[0]	I				
	PE1RP[0]	I				
	PE1TN[0]	O				
	PE1TP[0]	O				
	PE2RN[3:0]	I				
	PE2RP[3:0]	I				
	PE2TN[3:0]	O				
	PE2TP[3:0]	O				
	PE3RN[0]	I				
	PE3RP[0]	I				
	PE3TN[0]	O				
	PE3TP[0]	O				
	PE4RN[0]	I				
	PE4RP[0]	I				
	PE4TN[0]	O				
	PE4TP[0]	O				
	PE5RN[0]	I				
	PE5RP[0]	I				
	PE5TN[0]	O				
	PE5TP[0]	O				
	PE6RN[0]	I				
	PE6RP[0]	I				
	PE6TN[0]	O				
	PE6TP[0]	O				
	PE7RN[0]	I				
	PE7RP[0]	I				
	PE7TN[0]	O				
	PE7TP[0]	O				
PE8RN[0]	I					

Table 8 Pin Characteristics (Part 1 of 3)

Function	Pin Name	Type	Buffer	I/O Type	Internal Resistor	Notes			
PCI Express Interface (cont.)	PE8RP[0]	I	CML	Serial Link					
	PE8TN[0]	O							
	PE8TP[0]	O							
	PE9RN[0]	I							
	PE9RP[0]	I							
	PE9TN[0]	O							
	PE9TP[0]	O							
	PE10RN[0]	I							
	PE10RP[0]	I							
	PE10TN[0]	O							
	PE10TP[0]	O							
	PE11RN[0]	I							
	PE11RP[0]	I							
	PE11TN[0]	O							
	PE11TP[0]	O							
	PE12RN[0]	I							
	PE12RP[0]	I							
	PE12TN[0]	O							
	PE12TP[0]	O							
	PE13RN[0]	I							
	PE13RP[0]	I							
	PE13TN[0]	O							
	PE13TP[0]	O							
	PE14RN[0]	I							
	PE14RP[0]	I							
	PE14TN[0]	O							
	PE14TP[0]	O							
	PE15RN[0]	I							
	PE15RP[0]	I							
	PE15TN[0]	O							
	PE15TP[0]	O							
		PEREFCLKN[3:0]			I	LVPECL/ CML	Diff. Clock Input		Refer to Table 9
		PEREFCLKP[3:0]			I				
	REFCLKM	I	LVTTTL	Input	pull-down				

Table 8 Pin Characteristics (Part 2 of 3)

Function	Pin Name	Type	Buffer	I/O Type	Internal Resistor	Notes
SMBus	MSMBADDR[4:1]	I	LVTTL		pull-up	
	MSMBCLK	I/O		STI <sup>1</sup>		
	MSMBDAT	I/O		STI		
	SSMBADDR[5,3:1]	I			pull-up	
	SSMBCLK	I/O		STI		
	SSMBDAT	I/O		STI		
General Purpose I/O	GPIO[31:0]	I/O	LVTTL		pull-up	
System Pins	CCLKDS	I	LVTTL	Input	pull-up	
	CCLKUS	I			pull-up	
	MSMBSMODE	I			pull-down	
	PERSTN	I				
	RSTHALT	I			pull-down	
	SWMODE[3:0]	I			pull-down	
EJTAG / JTAG	JTAG_TCK	I	LVTTL	STI	pull-up	
	JTAG_TDI	I		STI	pull-up	
	JTAG_TDO	O				
	JTAG_TMS	I		STI	pull-up	
	JTAG_TRST_N	I		STI	pull-up	External pull-down

Table 8 Pin Characteristics (Part 3 of 3)

<sup>1</sup>: Schmitt Trigger Input (STI).

# Logic Diagram — PES22H16

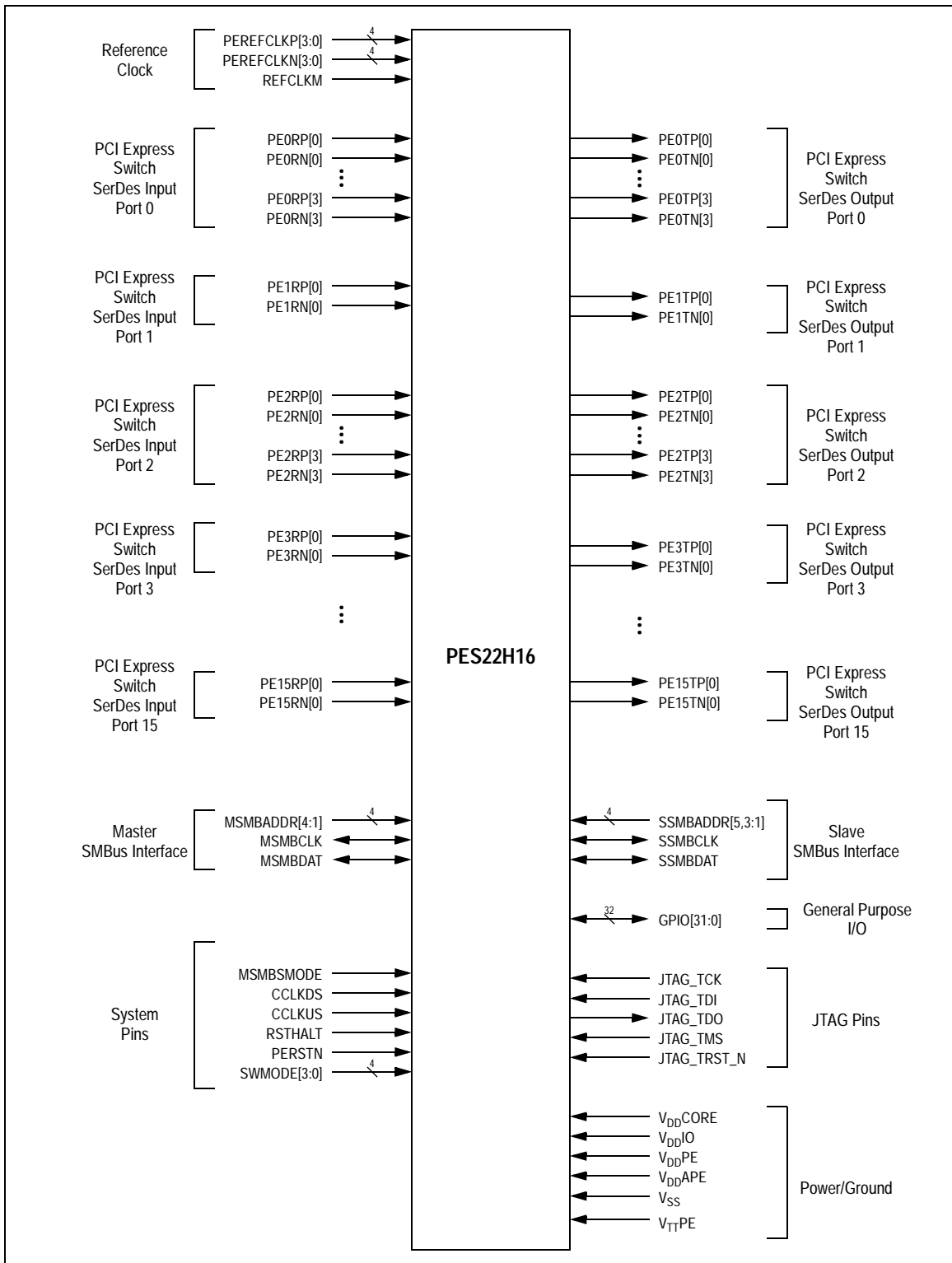


Figure 4 PES22H16 Logic Diagram

**Note:** GPIO pins 22 and 25 are not available in the 23x23mm package.

## System Clock Parameters

Values based on systems running at recommended supply voltages and operating temperatures, as shown in Tables 13 and 15.

Parameter	Description	Min	Typical	Max	Unit
<b>PEREFCLK</b>					
Refclk <sub>FREQ</sub>	Input reference clock frequency range	100		125 <sup>1</sup>	MHz
Refclk <sub>DC</sub> <sup>2</sup>	Duty cycle of input clock	40	50	60	%
T <sub>R</sub> , T <sub>F</sub>	Rise/Fall time of input clocks			0.2*RCUI	RCUI <sup>3</sup>
V <sub>SW</sub>	Differential input voltage swing <sup>4</sup>	0.6		1.6	V
T <sub>jitter</sub>	Input clock jitter (cycle-to-cycle)			125	ps
R <sub>T</sub>	Termination Resistor		110		Ohms

**Table 9 Input Clock Requirements**

<sup>1</sup> The input clock frequency will be either 100 or 125 MHz depending on signal REFCLKM.

<sup>2</sup> ClkIn must be AC coupled. Use 0.01 — 0.1 μF ceramic capacitors.

<sup>3</sup> RCUI (Reference Clock Unit Interval) refers to the reference clock period.

<sup>4</sup> AC coupling required.

## AC Timing Characteristics

Parameter	Description	Min <sup>1</sup>	Typical <sup>1</sup>	Max <sup>1</sup>	Units
<b>PCIe Transmit</b>					
UI	Unit Interval	399.88	400	400.12	ps
T <sub>TX-EYE</sub>	Minimum Tx Eye Width	0.7	.9		UI
T <sub>TX-EYE-MEDIAN-TO-MAX-JITTER</sub>	Maximum time between the jitter median and maximum deviation from the median			0.15	UI
T <sub>TX-RISE</sub> , T <sub>TX-FALL</sub>	D+ / D- Tx output rise/fall time	50	90		ps
T <sub>TX-IDLE-MIN</sub>	Minimum time in idle	50			UI
T <sub>TX-IDLE-SET-TO-IDLE</sub>	Maximum time to transition to a valid Idle after sending an Idle ordered set			20	UI
T <sub>TX-IDLE-TO-DIFF-DATA</sub>	Maximum time to transition from valid idle to diff data			20	UI
T <sub>TX-SKEW</sub>	Transmitter data skew between any 2 lanes		500	1300	ps
<b>PCIe Receive</b>					
UI	Unit Interval	399.88	400	400.12	ps
T <sub>RX-EYE (with jitter)</sub>	Minimum Receiver Eye Width (jitter tolerance)	0.4			UI
T <sub>RX-EYE-MEDIUM TO MAX JITTER</sub>	Max time between jitter median & max deviation			0.3	UI
T <sub>RX-IDLE-DET-DIFF-ENTER TIME</sub>	Unexpected Idle Enter Detect Threshold Integration Time			10	ms
T <sub>RX-SKEW</sub>	Lane to lane input skew			20	ns

**Table 10 PCIe AC Timing Characteristics**

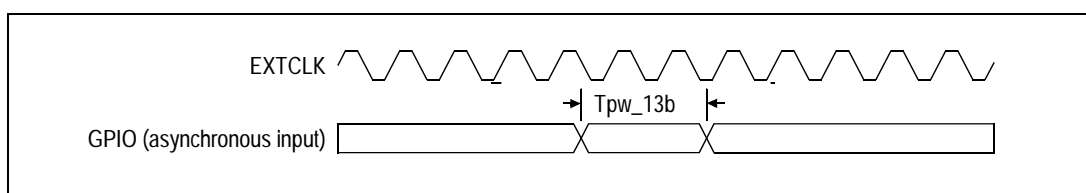
<sup>1</sup> Minimum, Typical, and Maximum values meet the requirements under PCI Specification 1.1

Signal	Symbol	Reference Edge	Min	Max	Unit	Timing Diagram Reference
<b>GPIO</b>						
GPIO[31:0] <sup>1</sup>	Tpw_13b <sup>2</sup>	None	50	—	ns	See Figure 5.

**Table 11 GPIO AC Timing Characteristics**

<sup>1</sup> GPIO signals must meet the setup and hold times if they are synchronous or the minimum pulse width if they are asynchronous.

<sup>2</sup> The values for this symbol were determined by calculation, not by testing.



**Figure 5 GPIO AC Timing Waveform**

Signal	Symbol	Reference Edge	Min	Max	Unit	Timing Diagram Reference
<b>JTAG</b>						
JTAG_TCK	Tper_16a	none	50.0	—	ns	See Figure 6.
	Thigh_16a, Tlow_16a		10.0	25.0	ns	
JTAG_TMS <sup>1</sup> , JTAG_TDI	Tsu_16b	JTAG_TCK rising	2.4	—	ns	
	Thld_16b		1.0	—	ns	
JTAG_TDO	Tdo_16c	JTAG_TCK falling	—	20	ns	
	Tdz_16c <sup>2</sup>		—	20	ns	
JTAG_TRST_N	Tpw_16d <sup>2</sup>	none	25.0	—	ns	

**Table 12 JTAG AC Timing Characteristics**

<sup>1</sup> The JTAG specification, IEEE 1149.1, recommends that JTAG\_TMS should be held at 1 while the signal applied at JTAG\_TRST\_N changes from 0 to 1. Otherwise, a race may occur if JTAG\_TRST\_N is deasserted (going from low to high) on a rising edge of JTAG\_TCK when JTAG\_TMS is low, because the TAP controller might go to either the Run-Test/Idle state or stay in the Test-Logic-Reset state.

<sup>2</sup> The values for this symbol were determined by calculation, not by testing.





Figure 6 JTAG AC Timing Waveform

## Recommended Operating Supply Voltages

Symbol	Parameter	Minimum	Typical	Maximum	Unit
V <sub>DD</sub> CORE	Internal logic supply	0.9	1.0	1.1	V
V <sub>DD</sub> I/O	I/O supply except for SerDes LVPECL/CML	3.0	3.3	3.6	V
V <sub>DD</sub> PE	PCI Express Digital Power	0.9	1.0	1.1	V
V <sub>DD</sub> APE	PCI Express Analog Power	0.9	1.0	1.1	V
V <sub>TT</sub> PE	PCI Express Serial Data Transmit Termination Voltage	1.425	1.5	1.575	V
V <sub>SS</sub>	Common ground	0	0	0	V

Table 13 PES22H16 Operating Voltages

## Absolute Maximum Voltage Rating

V <sub>DD</sub> Core	V <sub>DD</sub> PE	V <sub>DD</sub> APE	V <sub>TT</sub> PE	V <sub>DD</sub> I/O
1.5V	1.5V	1.5V	2.5V	5.0V

Table 14 PES22H16 Absolute Maximum Voltage Rating

**Warning:** For proper and reliable operation in adherence with this data sheet, the device should not exceed the recommended operating voltages in Table 13. The absolute maximum operating voltages in Table 14 are offered to provide guidelines for voltage excursions outside the recommended voltage ranges. Device functionality is not guaranteed at these conditions and sustained operation at these values or any exposure to voltages outside the maximum range may adversely affect device functionality and reliability.

## Power-Up Sequence

This section describes the sequence in which various voltages must be applied to the part during power-up to ensure proper functionality. For the PES22H16, the power-up sequence must be as follows:

1.  $V_{DD}I/O$  — 3.3V
2.  $V_{DD}Core$ ,  $V_{DD}PE$ ,  $V_{DD}APE$  — 1.0V
3.  $V_{TTPE}$  — 1.5V

When powering up, each voltage level must ramp and stabilize prior to applying the next voltage in the sequence to ensure internal latch-up issues are avoided. There are no maximum time limitations in ramping to valid power levels. The power-down sequence must be in the reverse order of the power-up sequence.

## Recommended Operating Temperature

Grade	Temperature
Commercial	0°C to +70°C Ambient
Industrial	-40°C to +85°C Ambient

Table 15 PES22H16 Operating Temperatures

## Power Consumption

Typical power is measured under the following conditions: 25°C Ambient, 35% total link usage on all ports, typical voltages defined in Table 13 (and also listed below).

Maximum power is measured under the following conditions: 70°C Ambient, 85% total link usage on all ports, maximum voltages defined in Table 13 (and also listed below).

Number of active Lanes per Port		Core Supply		PCIe Digital Supply		PCIe Analog Supply		PCIe Termination Supply		I/O Supply		Total	
		Typ 1.0V	Max 1.1V	Typ 1.0V	Max 1.1V	Typ 1.0V	Max 1.1V	Typ 1.5V	Max 1.575V	Typ 3.3V	Max 3.6V	Typ Power	Max Power
Two x4 and fourteen x1	<b>mA</b>	1900	2364	1400	1727	800	1000	535	762	5	5	—	—
	<b>Watts</b>	1.9	2.6	1.4	1.9	0.8	1.1	0.8	1.2	0.018	0.02	4.92	6.82

Table 16 PES22H16 Power Consumption

## Thermal Considerations

This section describes thermal considerations for the PES22H16 (23mm<sup>2</sup> FCBGA484 package). The data in Table 17 below contains information that is relevant to the thermal performance of the PES22H16 switch.

Symbol	Parameter	Value	Units	Conditions
$T_{J(max)}$	Junction Temperature	125	°C	Maximum
$T_{A(max)}$	Ambient Temperature	70	°C	Maximum for commercial-rated products
$\theta_{JA(Effective)}$	Effective Thermal Resistance, Junction-to-Ambient	13.4	°C/W	Zero air flow
		7.2	°C/W	1 m/S air flow
		6.2	°C/W	2 m/S air flow
$\theta_{JB}$	Thermal Resistance, Junction-to-Board	2.5	°C/W	
$\theta_{JC}$	Thermal Resistance, Junction-to-Case	0.1	°C/W	
P	Power Dissipation of the Device	6.82	Watts	Maximum

**Table 17 Thermal Specifications for PES22H16, 23x23mm FCBGA484 Package**

**Note:** The parameter  $\theta_{JA(eff)}$  is not the *absolute* thermal resistance for the package as defined by JEDEC (JESD-51). Because resistance can vary with the number of board layers, size of the board, and airflow,  $\theta_{JA(eff)}$  is the *effective* thermal resistance. The values for effective  $\theta_{JA}$  given above are based on a 10-layer, standard height, full length (4.3"x12.2") PCIe add-in card.

## DC Electrical Characteristics

Values based on systems running at recommended supply voltages, as shown in Table 13.

**Note:** See Table 8, Pin Characteristics, for a complete I/O listing.

I/O Type	Parameter	Description	Min <sup>1</sup>	Typ <sup>1</sup>	Max <sup>1</sup>	Unit	Conditions
Serial Link	<b>PCIe Transmit</b>						
	V <sub>TX-DIFFp-p</sub>	Differential peak-to-peak output voltage	800		1200	mV	
	V <sub>TX-DE-RATIO</sub>	De-emphasized differential output voltage	-3		-4	dB	
	V <sub>TX-DC-CM</sub>	DC Common mode voltage	-0.1	1	3.7	V	
	V <sub>TX-CM-ACP</sub>	RMS AC peak common mode output voltage			20	mV	
	V <sub>TX-CM-DC-active-idle-delta</sub>	Abs delta of DC common mode voltage between L0 and idle			100	mV	
	V <sub>TX-CM-DC-line-delta</sub>	Abs delta of DC common mode voltage between D+ and D-			25	mV	
	V <sub>TX-Idle-DiffP</sub>	Electrical idle diff peak output			20	mV	
	V <sub>TX-RCV-Detect</sub>	Voltage change during receiver detection			600	mV	
	RL <sub>TX-DIFF</sub>	Transmitter Differential Return loss	12			dB	
	RL <sub>TX-CM</sub>	Transmitter Common Mode Return loss	6			dB	
	Z <sub>TX-DEFF-DC</sub>	DC Differential TX impedance	80	100	120	Ω	
	Z <sub>OSE</sub>	Single ended TX Impedance	40	50	60	Ω	
	Transmitter Eye Diagram	TX Eye Height (De-emphasized bits)	505	650		mV	
	Transmitter Eye Diagram	TX Eye Height (Transition bits)	800	950		mV	
	<b>PCIe Receive</b>						
	V <sub>RX-DIFFp-p</sub>	Differential input voltage (peak-to-peak)	175		1200	mV	
	V <sub>RX-CM-AC</sub>	Receiver common-mode voltage for AC coupling			150	mV	
	RL <sub>RX-DIFF</sub>	Receiver Differential Return Loss	15			dB	
	RL <sub>RX-CM</sub>	Receiver Common Mode Return Loss	6			dB	
	Z <sub>RX-DIFF-DC</sub>	Differential input impedance (DC)	80	100	120	Ω	
	Z <sub>RX-COMM-DC</sub>	Single-ended input impedance	40	50	60	Ω	
	Z <sub>RX-COMM-HIGH-Z-DC</sub>	Powered down input common mode impedance (DC)	200k	350k		Ω	
V <sub>RX-IDLE-DET-DIFFp-p</sub>	Electrical idle detect threshold	65		175	mV		
<b>PCIe REFCLK</b>							
	C <sub>IN</sub>	Input Capacitance	1.5	—		pF	

Table 18 DC Electrical Characteristics (Part 1 of 2)

I/O Type	Parameter	Description	Min <sup>1</sup>	Typ <sup>1</sup>	Max <sup>1</sup>	Unit	Conditions
<b>Other I/Os</b>							
LOW Drive Output	I <sub>OL</sub>		—	2.5	—	mA	V <sub>OL</sub> = 0.4v
	I <sub>OH</sub>		—	-5.5	—	mA	V <sub>OH</sub> = 1.5V
High Drive Output	I <sub>OL</sub>		—	12.0	—	mA	V <sub>OL</sub> = 0.4v
	I <sub>OH</sub>		—	-20.0	—	mA	V <sub>OH</sub> = 1.5V
Schmitt Trigger Input (STI)	V <sub>IL</sub>		-0.3	—	0.8	V	—
	V <sub>IH</sub>		2.0	—	V <sub>DD</sub> I/O + 0.5	V	—
Input	V <sub>IL</sub>		-0.3	—	0.8	V	—
	V <sub>IH</sub>		2.0	—	V <sub>DD</sub> I/O + 0.5	V	—
Capacitance	C <sub>IN</sub>		—	—	8.5	pF	—
Leakage	Inputs		—	—	± 10	μA	V <sub>DD</sub> I/O (max)
	I/O <sub>LEAK</sub> w/o Pull-ups/downs		—	—	± 10	μA	V <sub>DD</sub> I/O (max)
	I/O <sub>LEAK</sub> WITH Pull-ups/downs		—	—	± 80	μA	V <sub>DD</sub> I/O (max)

Table 18 DC Electrical Characteristics (Part 2 of 2)

<sup>1</sup>: Minimum, Typical, and Maximum values meet the requirements under PCI Specification 1.0a.

## Package Pinout — 484-BGA Signal Pinout for PES22H16

The following table lists the pin numbers and signal names for the PES22H16 device.

Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt
A1	V <sub>DD</sub> I/O		B13	V <sub>SS</sub>		D3	GPIO_27	1	E15	V <sub>SS</sub>	
A2	GPIO_16	1	B14	PE2TP03		D4	GPIO_23	1	E16	V <sub>DD</sub> PE	
A3	V <sub>SS</sub>		B15	PE2TP02		D5	GPIO_20	1	E17	V <sub>DD</sub> PE	
A4	PE9TN00		B16	V <sub>SS</sub>		D6	V <sub>SS</sub>		E18	JTAG_TRST_N	
A5	PE8TN00		B17	PE2TN01		D7	PE9RP00		E19	SSMBCLK	
A6	V <sub>SS</sub>		B18	PE2TN00		D8	PE9RN00		E20	SSMBADDR_2	
A7	PE3RP00		B19	MSMBADDR_3		D9	PE8RP00		E21	PE1TP00	
A8	PE2RP03		B20	JTAG_TDO		D10	PE8RN00		E22	PE1TN00	
A9	V <sub>SS</sub>		B21	PERSTN		D11	V <sub>SS</sub>		F1	PE10RP00	
A10	PEREFCLKN1		B22	JTAG_TDI		D12	PE2RP02		F2	PE10RN00	
A11	V <sub>SS</sub>		C1	V <sub>DD</sub> I/O		D13	PE2RN02		F3	V <sub>SS</sub>	
A12	PE3TN00		C2	GPIO_21	1	D14	PE2RP01		F4	GPIO_30	
A13	V <sub>SS</sub>		C3	GPIO_19	1	D15	PE2RN01		F5	V <sub>DD</sub> I/O	
A14	PE2TN03		C4	V <sub>SS</sub>		D16	PE2RP00		F6	V <sub>DD</sub> I/O	
A15	PE2TN02		C5	V <sub>SS</sub>		D17	PE2RN00		F7	V <sub>DD</sub> PE	
A16	V <sub>SS</sub>		C6	V <sub>SS</sub>		D18	MSMBADDR_1		F8	V <sub>DD</sub> PE	
A17	PE2TP01		C7	V <sub>SS</sub>		D19	V <sub>DD</sub> I/O		F9	V <sub>DD</sub> PE	
A18	PE2TP00		C8	V <sub>SS</sub>		D20	CCLKDS		F10	V <sub>DD</sub> CORE	
A19	MSMBSMODE		C9	V <sub>SS</sub>		D21	SSMBADDR_1		F11	V <sub>DD</sub> CORE	
A20	MSMBDAT		C10	V <sub>SS</sub>		D22	SSMBADDR_3		F12	V <sub>DD</sub> CORE	
A21	JTAG_TMS		C11	V <sub>SS</sub>		E1	V <sub>SS</sub>		F13	V <sub>DD</sub> CORE	
A22	V <sub>SS</sub>		C12	V <sub>SS</sub>		E2	V <sub>SS</sub>		F14	V <sub>DD</sub> PE	
B1	V <sub>SS</sub>		C13	V <sub>SS</sub>		E3	GPIO_31	1	F15	V <sub>DD</sub> PE	
B2	GPIO_18	1	C14	V <sub>SS</sub>		E4	GPIO_28	1	F16	V <sub>DD</sub> I/O	
B3	V <sub>SS</sub>		C15	V <sub>SS</sub>		E5	GPIO_26	1	F17	V <sub>DD</sub> I/O	
B4	PE9TP00		C16	V <sub>SS</sub>		E6	GPIO_17	1	F18	SSMBADDR_5	
B5	PE8TP00		C17	V <sub>SS</sub>		E7	V <sub>DD</sub> PE		F19	V <sub>SS</sub>	
B6	V <sub>SS</sub>		C18	MSMBADDR_4		E8	V <sub>SS</sub>		F20	V <sub>SS</sub>	
B7	PE3RN00		C19	MSMBADDR_2		E9	V <sub>TT</sub> PE		F21	PE0TN03	
B8	PE2RN03		C20	MSMBCLK		E10	V <sub>TT</sub> PE		F22	PE0TP03	
B9	V <sub>SS</sub>		C21	SSMBDAT		E11	V <sub>DD</sub> PEA		G1	PE11RP00	
B10	PEREFCLKP1		C22	JTAG_TCK		E12	V <sub>DD</sub> PEA		G2	PE11RN00	
B11	V <sub>SS</sub>		D1	GPIO_29		E13	V <sub>TT</sub> PE		G3	V <sub>SS</sub>	
B12	PE3TP00		D2	GPIO_24	1	E14	V <sub>TT</sub> PE		G4	V <sub>SS</sub>	

Table 19 PES22H16 Signal Pin-Out (Part 1 of 4)

Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt
G5	V <sub>DD</sub> I/O		H20	V <sub>SS</sub>		K13	V <sub>SS</sub>		M6	V <sub>SS</sub>	
G6	V <sub>DD</sub> PE		H21	PE0TN02		K14	V <sub>DD</sub> CORE		M7	V <sub>SS</sub>	
G7	V <sub>SS</sub>		H22	PE0TP02		K15	V <sub>DD</sub> CORE		M8	V <sub>DD</sub> CORE	
G8	V <sub>DD</sub> CORE		J1	PE10TN00		K16	V <sub>SS</sub>		M9	V <sub>DD</sub> CORE	
G9	V <sub>DD</sub> CORE		J2	PE10TP00		K17	V <sub>DD</sub> PE		M10	V <sub>SS</sub>	
G10	V <sub>SS</sub>		J3	V <sub>SS</sub>		K18	V <sub>TT</sub> PE		M11	V <sub>DD</sub> CORE	
G11	V <sub>DD</sub> CORE		J4	V <sub>SS</sub>		K19	PE0RP03		M12	V <sub>DD</sub> CORE	
G12	V <sub>DD</sub> CORE		J5	V <sub>TT</sub> PE		K20	V <sub>SS</sub>		M13	V <sub>SS</sub>	
G13	V <sub>SS</sub>		J6	V <sub>DD</sub> PE		K21	V <sub>SS</sub>		M14	V <sub>DD</sub> CORE	
G14	V <sub>DD</sub> CORE		J7	V <sub>SS</sub>		K22	V <sub>SS</sub>		M15	V <sub>DD</sub> CORE	
G15	V <sub>DD</sub> CORE		J8	V <sub>DD</sub> CORE		L1	V <sub>SS</sub>		M16	V <sub>SS</sub>	
G16	V <sub>SS</sub>		J9	V <sub>DD</sub> CORE		L2	V <sub>SS</sub>		M17	V <sub>SS</sub>	
G17	V <sub>DD</sub> I/O		J10	V <sub>SS</sub>		L3	V <sub>SS</sub>		M18	V <sub>DD</sub> PEA	
G18	V <sub>SS</sub>		J11	V <sub>DD</sub> CORE		L4	V <sub>SS</sub>		M19	PE0RN02	
G19	PE1RN00		J12	V <sub>DD</sub> CORE		L5	V <sub>DD</sub> PEA		M20	V <sub>SS</sub>	
G20	V <sub>SS</sub>		J13	V <sub>SS</sub>		L6	V <sub>SS</sub>		M21	V <sub>SS</sub>	
G21	V <sub>SS</sub>		J14	V <sub>DD</sub> CORE		L7	V <sub>SS</sub>		M22	V <sub>SS</sub>	
G22	V <sub>SS</sub>		J15	V <sub>DD</sub> CORE		L8	V <sub>DD</sub> CORE		N1	V <sub>SS</sub>	
H1	V <sub>SS</sub>		J16	V <sub>SS</sub>		L9	V <sub>DD</sub> CORE		N2	V <sub>SS</sub>	
H2	V <sub>SS</sub>		J17	V <sub>DD</sub> PE		L10	V <sub>SS</sub>		N3	V <sub>SS</sub>	
H3	V <sub>SS</sub>		J18	V <sub>TT</sub> PE		L11	V <sub>DD</sub> CORE		N4	V <sub>SS</sub>	
H4	V <sub>SS</sub>		J19	PE0RN03		L12	V <sub>DD</sub> CORE		N5	V <sub>TT</sub> PE	
H5	V <sub>DD</sub> PE		J20	V <sub>SS</sub>		L13	V <sub>SS</sub>		N6	V <sub>SS</sub>	
H6	V <sub>DD</sub> PE		J21	PE0TP01		L14	V <sub>DD</sub> CORE		N7	V <sub>SS</sub>	
H7	V <sub>SS</sub>		J22	PE0TN01		L15	V <sub>DD</sub> CORE		N8	V <sub>DD</sub> CORE	
H8	V <sub>DD</sub> CORE		K1	PE11TN00		L16	V <sub>SS</sub>		N9	V <sub>DD</sub> CORE	
H9	V <sub>DD</sub> CORE		K2	PE11TP00		L17	V <sub>SS</sub>		N10	V <sub>SS</sub>	
H10	V <sub>SS</sub>		K3	V <sub>SS</sub>		L18	V <sub>DD</sub> PEA		N11	V <sub>DD</sub> CORE	
H11	V <sub>DD</sub> CORE		K4	V <sub>SS</sub>		L19	PE0RP02		N12	V <sub>DD</sub> CORE	
H12	V <sub>DD</sub> CORE		K5	V <sub>TT</sub> PE		L20	V <sub>SS</sub>		N13	V <sub>SS</sub>	
H13	V <sub>SS</sub>		K6	V <sub>SS</sub>		L21	PE0TP00		N14	V <sub>DD</sub> CORE	
H14	V <sub>DD</sub> CORE		K7	V <sub>SS</sub>		L22	PE0TN00		N15	V <sub>DD</sub> CORE	
H15	V <sub>DD</sub> CORE		K8	V <sub>DD</sub> CORE		M1	PEREFCLKN2		N16	V <sub>SS</sub>	
H16	V <sub>SS</sub>		K9	V <sub>DD</sub> CORE		M2	PEREFCLKP2		N17	V <sub>SS</sub>	
H17	V <sub>DD</sub> PE		K10	V <sub>SS</sub>		M3	V <sub>SS</sub>		N18	V <sub>TT</sub> PE	
H18	V <sub>DD</sub> PE		K11	V <sub>DD</sub> CORE		M4	V <sub>SS</sub>		N19	V <sub>SS</sub>	
H19	PE1RP00		K12	V <sub>DD</sub> CORE		M5	V <sub>DD</sub> PEA		N20	V <sub>SS</sub>	

Table 19 PES22H16 Signal Pin-Out (Part 2 of 4)

Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt
N21	PEREFCLKN0		R14	V <sub>DD</sub> CORE		U7	V <sub>DD</sub> PE		V22	PE15TP00	
N22	PEREFCLKP0		R15	V <sub>DD</sub> CORE		U8	V <sub>DD</sub> PE		W1	V <sub>SS</sub>	
P1	PE4TN00		R16	V <sub>SS</sub>		U9	V <sub>DD</sub> PE		W2	V <sub>SS</sub>	
P2	PE4TP00		R17	V <sub>DD</sub> PE		U10	V <sub>DD</sub> CORE		W3	V <sub>SS</sub>	
P3	V <sub>SS</sub>		R18	V <sub>SS</sub>		U11	V <sub>DD</sub> CORE		W4	REFCLKM	
P4	V <sub>SS</sub>		R19	PE15RN00		U12	V <sub>DD</sub> CORE		W5	RSTHALT	
P5	V <sub>TT</sub> PE		R20	V <sub>SS</sub>		U13	V <sub>DD</sub> CORE		W6	SWMODE_1	
P6	V <sub>DD</sub> PE		R21	PE0RN01		U14	V <sub>DD</sub> PE		W7	V <sub>SS</sub>	
P7	V <sub>SS</sub>		R22	PE0RP01		U15	V <sub>DD</sub> PE		W8	V <sub>SS</sub>	
P8	V <sub>DD</sub> CORE		T1	V <sub>SS</sub>		U16	V <sub>DD</sub> I/O		W9	V <sub>SS</sub>	
P9	V <sub>DD</sub> CORE		T2	V <sub>SS</sub>		U17	V <sub>DD</sub> I/O		W10	V <sub>SS</sub>	
P10	V <sub>SS</sub>		T3	V <sub>SS</sub>		U18	V <sub>SS</sub>		W11	V <sub>DD</sub> PEA	
P11	V <sub>DD</sub> CORE		T4	V <sub>SS</sub>		U19	PE14RN00		W12	V <sub>SS</sub>	
P12	V <sub>DD</sub> CORE		T5	V <sub>SS</sub>		U20	V <sub>SS</sub>		W13	V <sub>SS</sub>	
P13	V <sub>SS</sub>		T6	V <sub>DD</sub> PE		U21	V <sub>SS</sub>		W14	V <sub>SS</sub>	
P14	V <sub>DD</sub> CORE		T7	V <sub>SS</sub>		U22	V <sub>SS</sub>		W15	V <sub>DD</sub> I/O	
P15	V <sub>DD</sub> CORE		T8	V <sub>DD</sub> CORE		V1	PE5RP00		W16	GPIO_01	
P16	V <sub>SS</sub>		T9	V <sub>DD</sub> CORE		V2	PE5RN00		W17	GPIO_03	
P17	V <sub>DD</sub> PE		T10	V <sub>SS</sub>		V3	V <sub>SS</sub>		W18	GPIO_04	
P18	V <sub>TT</sub> PE		T11	V <sub>DD</sub> CORE		V4	V <sub>SS</sub>		W19	GPIO_08	1
P19	PE15RP00		T12	V <sub>DD</sub> CORE		V5	V <sub>DD</sub> I/O		W20	V <sub>SS</sub>	
P20	V <sub>SS</sub>		T13	V <sub>SS</sub>		V6	V <sub>DD</sub> I/O		W21	PE14TN00	
P21	V <sub>SS</sub>		T14	V <sub>DD</sub> CORE		V7	V <sub>SS</sub>		W22	PE14TP00	
P22	V <sub>SS</sub>		T15	V <sub>DD</sub> CORE		V8	V <sub>DD</sub> PE		Y1	V <sub>DD</sub> I/O	
R1	PE5TN00		T16	V <sub>SS</sub>		V9	V <sub>TT</sub> PE		Y2	CCLKUS	
R2	PE5TP00		T17	V <sub>DD</sub> PE		V10	V <sub>TT</sub> PE		Y3	V <sub>DD</sub> I/O	
R3	V <sub>SS</sub>		T18	V <sub>DD</sub> PE		V11	V <sub>DD</sub> PEA		Y4	SWMODE_0	
R4	V <sub>SS</sub>		T19	PE14RP00		V12	V <sub>TT</sub> PE		Y5	V <sub>SS</sub>	
R5	V <sub>DD</sub> PE		T20	V <sub>SS</sub>		V13	V <sub>TT</sub> PE		Y6	V <sub>SS</sub>	
R6	V <sub>DD</sub> PE		T21	PE0RN00		V14	V <sub>DD</sub> PE		Y7	V <sub>SS</sub>	
R7	V <sub>SS</sub>		T22	PE0RP00		V15	V <sub>DD</sub> PE		Y8	V <sub>SS</sub>	
R8	V <sub>DD</sub> CORE		U1	PE4RP00		V16	V <sub>DD</sub> I/O		Y9	V <sub>SS</sub>	
R9	V <sub>DD</sub> CORE		U2	PE4RN00		V17	GPIO_06	1	Y10	V <sub>SS</sub>	
R10	V <sub>SS</sub>		U3	V <sub>SS</sub>		V18	GPIO_11	1	Y11	V <sub>SS</sub>	
R11	V <sub>DD</sub> CORE		U4	V <sub>SS</sub>		V19	V <sub>SS</sub>		Y12	V <sub>SS</sub>	
R12	V <sub>DD</sub> CORE		U5	V <sub>SS</sub>		V20	V <sub>SS</sub>		Y13	V <sub>SS</sub>	
R13	V <sub>SS</sub>		U6	V <sub>DD</sub> I/O		V21	PE15TN00		Y14	V <sub>SS</sub>	

**Table 19 PES22H16 Signal Pin-Out (Part 3 of 4)**



Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt
Y15	V <sub>SS</sub>		AA6	PE7RN00		AA19	GPIO_05	1	AB10	V <sub>SS</sub>	
Y16	V <sub>SS</sub>		AA7	V <sub>SS</sub>		AA20	V <sub>DD</sub> I/O		AB11	PEREFCLKN3	
Y17	V <sub>SS</sub>		AA8	PE6TP00		AA21	GPIO_12	1	AB12	V <sub>SS</sub>	
Y18	GPIO_00		AA9	PE7TP00		AA22	GPIO_14	1	AB13	PE12TN00	
Y19	GPIO_07	1	AA10	V <sub>SS</sub>		AB1	V <sub>DD</sub> I/O		AB14	PE13TN00	
Y20	GPIO_09	1	AA11	PEREFCLKP3		AB2	V <sub>SS</sub>		AB15	V <sub>SS</sub>	
Y21	V <sub>SS</sub>		AA12	V <sub>SS</sub>		AB3	SWMODE_2		AB16	PE12RP00	
Y22	V <sub>SS</sub>		AA13	PE12TP00		AB4	V <sub>SS</sub>		AB17	PE13RP00	
AA1	V <sub>SS</sub>		AA14	PE13TP00		AB5	PE6RP00		AB18	V <sub>SS</sub>	
AA2	V <sub>DD</sub> I/O		AA15	V <sub>SS</sub>		AB6	PE7RP00		AB19	GPIO_02	
AA3	SWMODE_3		AA16	PE12RN00		AB7	V <sub>SS</sub>		AB20	GPIO_10	1
AA4	V <sub>SS</sub>		AA17	PE13RN00		AB8	PE6TN00		AB21	GPIO_13	1
AA5	PE6RN00		AA18	V <sub>SS</sub>		AB9	PE7TN00		AB22	GPIO_15	

Table 19 PES22H16 Signal Pin-Out (Part 4 of 4)

Alternate Signal Functions

Pin	GPIO	Alternate	Pin	GPIO	Alternate
AA19	GPIO_05	GPEN	E6	GPIO_17	P12RSTN
V17	GPIO_06	P1RSTN	B2	GPIO_18	P13RSTN
Y19	GPIO_07	P2RSTN	C3	GPIO_19	P14RSTN
W19	GPIO_08	P3RSTN	D5	GPIO_20	P15RSTN
Y20	GPIO_09	P4RSTN	C2	GPIO_21	IOEXPINTN0
AB20	GPIO_10	P5RSTN	D4	GPIO_23	IOEXPINTN2
V18	GPIO_11	P6RSTN	D2	GPIO_24	IOEXPINTN3
AA21	GPIO_12	P7RSTN	E5	GPIO_26	IOEXPINTN5
AB21	GPIO_13	P8RSTN	D3	GPIO_27	IOEXPINTN6
AA22	GPIO_14	P9RSTN	E4	GPIO_28	IOEXPINTN7
AB22	GPIO_15	P10RSTN	E3	GPIO_31	IOEXPINTN10
A2	GPIO_16	P11RSTN	—	—	—

Table 20 PES22H16 Alternate Signal Functions

Power Pins

V <sub>DD</sub> Core	V <sub>DD</sub> Core	V <sub>DD</sub> Core	V <sub>DD</sub> Core	V <sub>DD</sub> IO	V <sub>DD</sub> PE	V <sub>DD</sub> PE	V <sub>DD</sub> PEA	V <sub>TT</sub> PE	
F10	J9	M8	P15	A1	E7	P6	E11	E9	
F11	J11	M9	R8	C1	E16	P17	E12	E10	
F12	J12	M11	R9	D19	E17	R5	L5	E13	
F13	J14	M12	R11	F5	F7	R6	L18	E14	
G8	J15	M14	R12	F6	F8	R17	M5	J5	
G9	K8	M15	R14	F16	F9	T6	M18	J18	
G11	K9	N8	R15	F17	F14	T17	V11	K5	
G12	K11	N9	T8	G5	F15	T18	W11	K18	
G14	K12	N11	T9	G17	G6	U7		N5	
G15	K14	N12	T11	U6	H5	U8		N18	
H8	K15	N14	T12	U16	H6	U9		P5	
H9	L8	N15	T14	U17	H17	U14		P18	
H11	L9	P8	T15	V5	H18	U15		V9	
H12	L11	P9	U10	V6	J6	V8		V10	
H14	L12	P11	U11	V16	J17	V14		V12	
H15	L14	P12	U12	W15	K17	V15		V13	
J8	L15	P14	U13	Y1					
				Y3					
				AA2					
				AA20					
				AB1					

Table 21 PES22H16 Power Pins

## Ground Pins

V <sub>SS</sub>	V <sub>SS</sub>	V <sub>SS</sub>	V <sub>SS</sub>	V <sub>SS</sub>	V <sub>SS</sub>	V <sub>SS</sub>
A3	C17	H16	L16	P4	U4	Y10
A6	D6	H20	L17	P7	U5	Y11
A9	D11	J3	L20	P10	U18	Y12
A11	E1	J4	M3	P13	U20	Y13
A13	E2	J7	M4	P16	U21	Y14
A16	E8	J10	M6	P20	U22	Y15
A22	E15	J13	M7	P21	V3	Y16
B1	F3	J16	M10	P22	V4	Y17
B3	F19	J20	M13	R3	V7	Y21
B6	F20	K3	M16	R4	V19	Y22
B9	G3	K4	M17	R7	V20	AA1
B11	G4	K6	M20	R10	W1	AA4
B13	G7	K7	M21	R13	W2	AA7
B16	G10	K10	M22	R16	W3	AA10
C4	G13	K13	N1	R18	W7	AA12
C5	G16	K16	N2	R20	W8	AA15
C6	G18	K20	N3	T1	W9	AA18
C7	G20	K21	N4	T2	W10	AB2
C8	G21	K22	N6	T3	W12	AB4
C9	G22	L1	N7	T4	W13	AB7
C10	H1	L2	N10	T5	W14	AB10
C11	H2	L3	N13	T7	W20	AB12
C12	H3	L4	N16	T10	Y5	AB15
C13	H4	L6	N17	T13	Y6	AB18
C14	H7	L7	N19	T16	Y7	
C15	H10	L10	N20	T20	Y8	
C16	H13	L13	P3	U3	Y9	

Table 22 PES22H16 Ground Pins

## Signals Listed Alphabetically

Signal Name	I/O Type	Location	Signal Category
CCLKDS	I	D20	System
CCLKUS	I	Y2	
GPIO_00	I/O	Y18	General Purpose Input/Output
GPIO_01	I/O	W16	
GPIO_02	I/O	AB19	
GPIO_03	I/O	W17	
GPIO_04	I/O	W18	
GPIO_05	I/O	AA19	
GPIO_06	I/O	V17	
GPIO_07	I/O	Y19	
GPIO_08	I/O	W19	
GPIO_09	I/O	Y20	
GPIO_10	I/O	AB20	
GPIO_11	I/O	V18	
GPIO_12	I/O	AA21	
GPIO_13	I/O	AB21	
GPIO_14	I/O	AA22	
GPIO_15	I/O	AB22	
GPIO_16	I/O	A2	
GPIO_17	I/O	E6	
GPIO_18	I/O	B2	
GPIO_19	I/O	C3	
GPIO_20	I/O	D5	
GPIO_21	I/O	C2	
GPIO_23	I/O	D4	
GPIO_24	I/O	D2	
GPIO_26	I/O	E5	
GPIO_27	I/O	D3	
GPIO_28	I/O	E4	
GPIO_29	I/O	D1	
GPIO_30	I/O	F4	
GPIO_31	I/O	E3	

Table 23 PES22H16 Alphabetical Signal List (Part 1 of 5)

Signal Name	I/O Type	Location	Signal Category
JTAG_TCK	I	C22	JTAG
JTAG_TDI	I	B22	
JTAG_TDO	O	B20	
JTAG_TMS	I	A21	
JTAG_TRST_N	I	E18	
MSMBADDR_1	I	D18	SMBus
MSMBADDR_2	I	C19	
MSMBADDR_3	I	B19	
MSMBADDR_4	I	C18	
MSMBCLK	I/O	C20	
MSMBDAT	I/O	A20	
MSMBSMODE	I	A19	System
PE0RN00	I	T21	PCI Express
PE0RN01	I	R21	
PE0RN02	I	M19	
PE0RN03	I	J19	
PE0RP00	I	T22	
PE0RP01	I	R22	
PE0RP02	I	L19	
PE0RP03	I	K19	
PE0TN00	O	L22	
PE0TN01	O	J22	
PE0TN02	O	H21	
PE0TN03	O	F21	
PE0TP00	O	L21	
PE0TP01	O	J21	
PE0TP02	O	H22	
PE0TP03	O	F22	
PE1RN00	I	G19	
PE1RP00	I	H19	
PE1TN00	O	E22	
PE1TP00	O	E21	
PE2RN00	I	D17	
PE2RN01	I	D15	
PE2RN02	I	D13	
PE2RN03	I	B8	

Table 23 PES22H16 Alphabetical Signal List (Part 2 of 5)

Signal Name	I/O Type	Location	Signal Category
PE2RP00	I	D16	PCI Express (Cont.)
PE2RP01	I	D14	
PE2RP02	I	D12	
PE2RP03	I	A8	
PE2TN00	O	B18	
PE2TN01	O	B17	
PE2TN02	O	A15	
PE2TN03	O	A14	
PE2TP00	O	A18	
PE2TP01	O	A17	
PE2TP02	O	B15	
PE2TP03	O	B14	
PE3RN00	I	B7	
PE3RP00	I	A7	
PE3TN00	O	A12	
PE3TP00	O	B12	
PE4RN00	I	U2	
PE4RP00	I	U1	
PE4TN00	O	P1	
PE4TP00	O	P2	
PE5RN00	I	V2	
PE5RP00	I	V1	
PE5TN00	O	R1	
PE5TP00	O	R2	
PE6RN00	I	AA5	
PE6RP00	I	AB5	
PE6TN00	O	AB8	
PE6TP00	O	AA8	
PE7RN00	I	AA6	
PE7RP00	I	AB6	
PE7TN00	O	AB9	
PE7TP00	O	AA9	
PE8RN00	I	D10	
PE8RP00	I	D9	
PE8TN00	O	A5	
PE8TP00	O	B5	

Table 23 PES22H16 Alphabetical Signal List (Part 3 of 5)

Signal Name	I/O Type	Location	Signal Category
PE9RN00	I	D8	PCI Express (Cont.)
PE9RP00	I	D7	
PE9TN00	O	A4	
PE9TP00	O	B4	
PE10RN00	I	F2	
PE10RP00	I	F1	
PE10TN00	O	J1	
PE10TP00	O	J2	
PE11RN00	I	G2	
PE11RP00	I	G1	
PE11TN00	O	K1	
PE11TP00	O	K2	
PE12RN00	I	AA16	
PE12RP00	I	AB16	
PE12TN00	O	AB13	
PE12TP00	O	AA13	
PE13RN00	I	AA17	
PE13RP00	I	AB17	
PE13TN00	O	AB14	
PE13TP00	O	AA14	
PE14RN00	I	U19	
PE14RP00	I	T19	
PE14TN00	O	W21	
PE14TP00	O	W22	
PE15RN00	I	R19	
PE15RP00	I	P19	
PE15TN00	O	V21	
PE15TP00	O	V22	
PEREFCLKN0	I	N21	
PEREFCLKN1	I	A10	
PEREFCLKN2	I	M1	
PEREFCLKN3	I	AB11	
PEREFCLKP0	I	N22	
PEREFCLKP1	I	B10	
PEREFCLKP2	I	M2	
PEREFCLKP3	I	AA11	

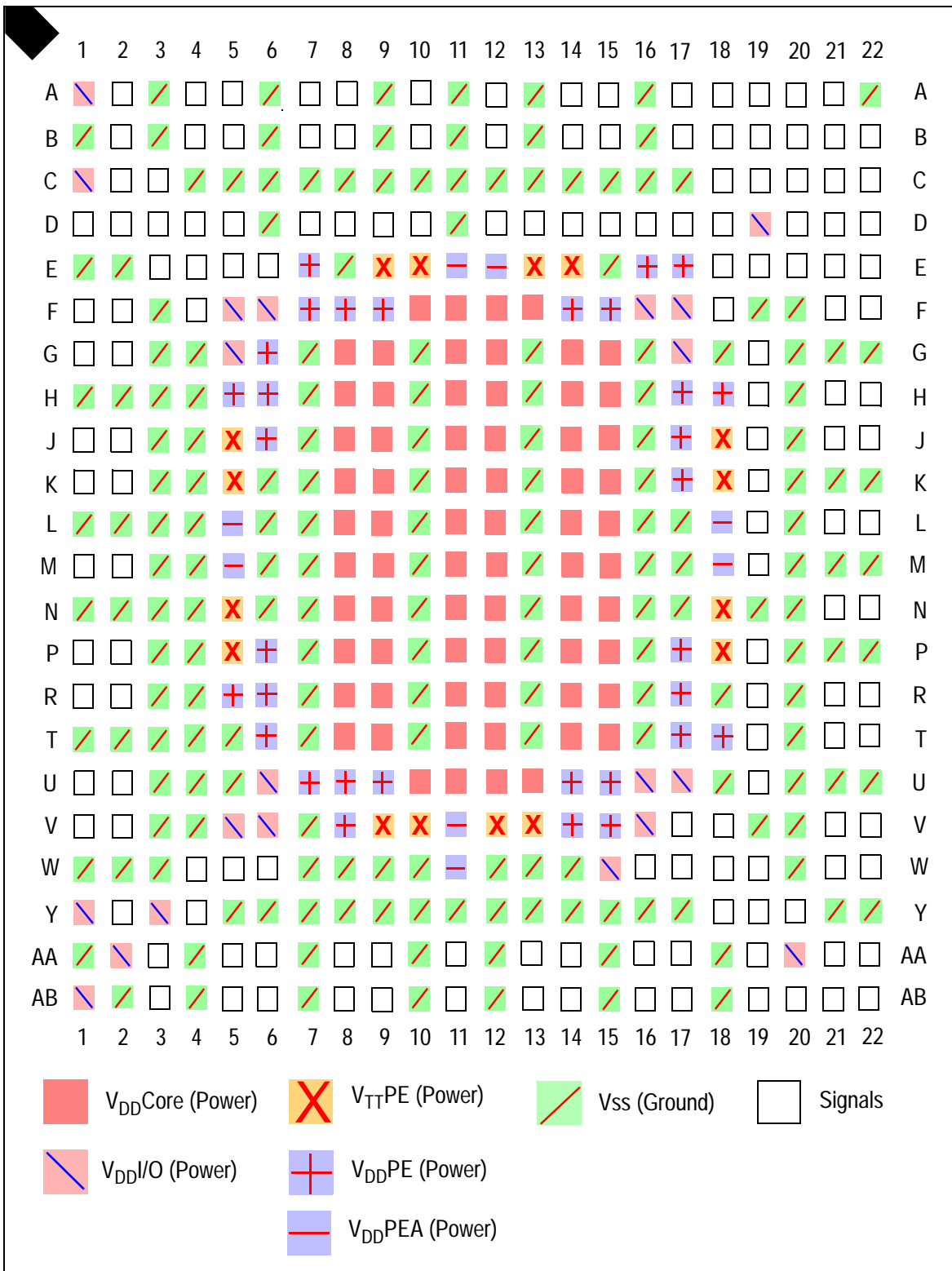
Table 23 PES22H16 Alphabetical Signal List (Part 4 of 5)

Signal Name	I/O Type	Location	Signal Category
PERSTN	I	B21	System
REFCLKM	I	W4	PCI Express
RSTHALT	I	W5	System
SSMBADDR_1	I	D21	SMBus
SSMBADDR_2	I	E20	
SSMBADDR_3	I	D22	
SSMBADDR_5	I	F18	
SSMBCLK	I/O	E19	
SSMBDAT	I/O	C21	
SWMODE_0	I	Y4	
SWMODE_1	I	W6	
SWMODE_2	I	AB3	
SWMODE_3	I	AA3	
V <sub>DD</sub> CORE, V <sub>DD</sub> -PEA, V <sub>DD</sub> IO, V <sub>DD</sub> PE, V <sub>TT</sub> PE	See Table 21 for a listing of power pins.		
V <sub>SS</sub>	See Table 22 for a listing of ground pins.		

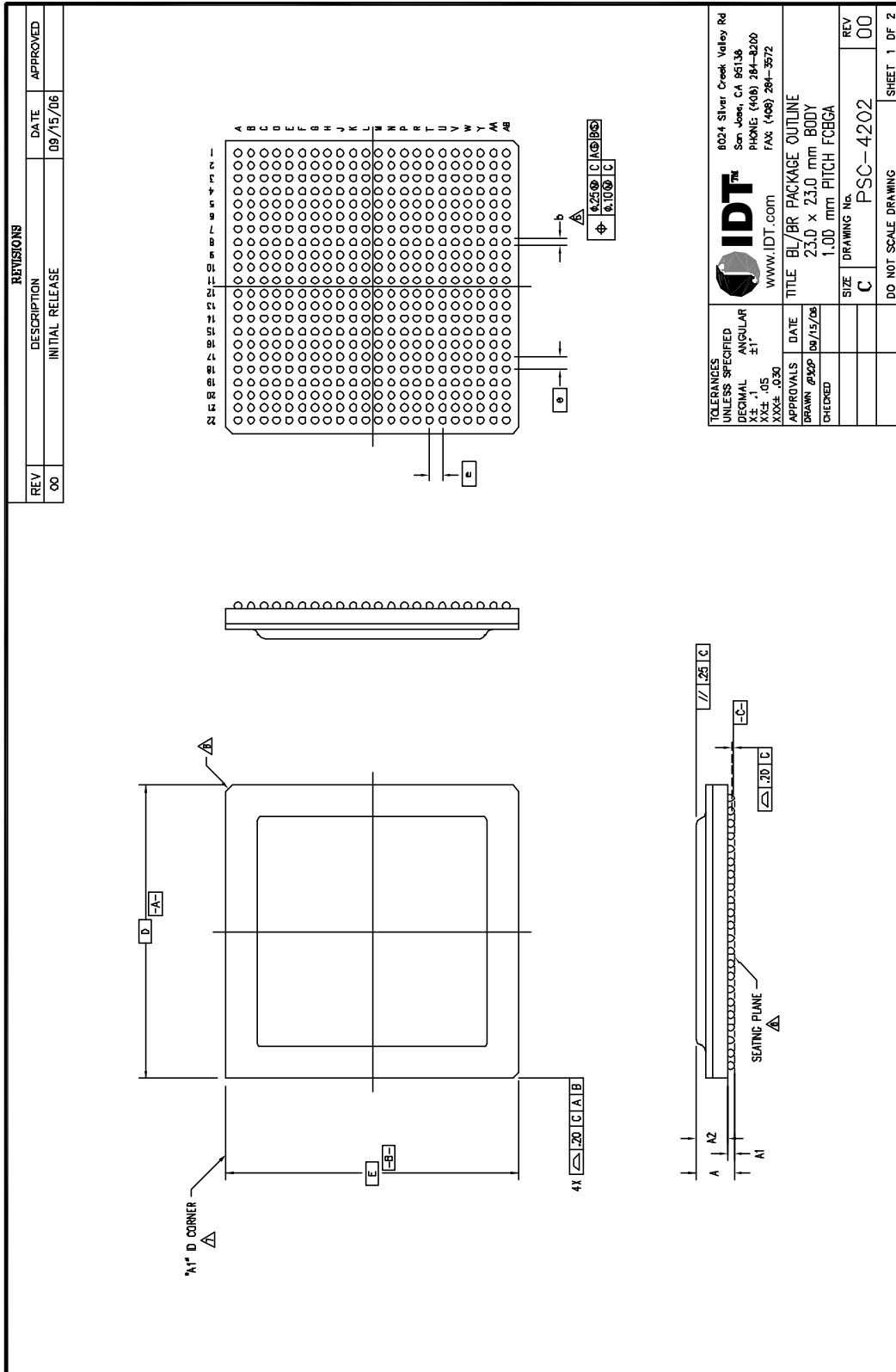
Table 23 PES22H16 Alphabetical Signal List (Part 5 of 5)



PES22H16 Pinout — Top View



PES22H16 Package Drawing — 484-Pin BL484/BR484



REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	08/15/06	

		8024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 264-8200 FAX: (408) 264-3572 WWW.IDT.COM	
TOLERANCES UNLESS SPECIFIED DECIMAL ANGULAR X ± .1 XX ± .05 XXX ± .030	APPROVALS DRAWN: $\sqrt{20} \text{ C}$ CHECKED	DATE: 08/15/06	TITLE: BL/BR PACKAGE OUTLINE 23.0 x 23.0 mm BODY 1.00 mm PITCH FBGA
SIZE: C DRAWING No.: PSC-4202		REV: 00	DO NOT SCALE DRAWING SHEET 1 OF 2

REVISIONS	
REV	DESCRIPTION
00	INITIAL RELEASE
	DATE: 09/15/06
	APPROVED:

### 484 BALLS

**NOTES:**

- 1 ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
- 2 \*e\* REPRESENTS THE BASIC SOLDER BALL GRID PITCH
- 3 \*M\* REPRESENTS THE MAXIMUM SOLDER BALL MATRIX SIZE
- 4 \*N\* REPRESENTS THE BALLCOUNT NUMBER

DIMENSION \*b\* IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]

SEATING PLANE AND PRIMARY DATUM [C] ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS

\*A1\* ID CORNER MUST BE IDENTIFIED BY CHAMFER, INK MARK, METALLIZED MARKING, INDENTATION OR OTHER FEATURE ON PACKAGE BODY

EXACT SHAPE OF EACH CORNER IS OPTIONAL

9 ALL DIMENSIONS ARE IN MILLIMETERS

SYMBOL	JEDEC VARIATION			NOTE
	NONE			
	MIN	NDM	MAX	
A	—	—	3.32	
A1	—	.50	—	
A2	2.36	—	2.72	
D	23.00 BSC			
E	23.00 BSC			
M	22			3
N	484			4
e	1.00 BSC			
b	.50	.64	.70	5
CENTER BALL MATRIX	N/A			

TOLERANCES UNLESS SPECIFIED DECIMAL ANGULAR X ± .1 ±1° XXX ± .030	4624 Silver Creek Valley Rd San Jose, CA 95136 PHONE: (408) 284-6200 FAX: (408) 284-3572 WWW.IDT.COM	TITLE: BL/BR PACKAGE OUTLINE 23.0 x 23.0 mm BODY 1.00 mm PITCH FCBGA
APPROVALS	DATE	REV
DRAWN: P/ADP	09/15/06	00
CHECKED		
	DRAWING No.	PSC-4202
	SIZE	C
	DO NOT SCALE DRAWING	SHEET 2 OF 2

## Revision History

**April 7, 2008:** Publication of Preliminary data sheet with 23x23mm FCBGA package option.

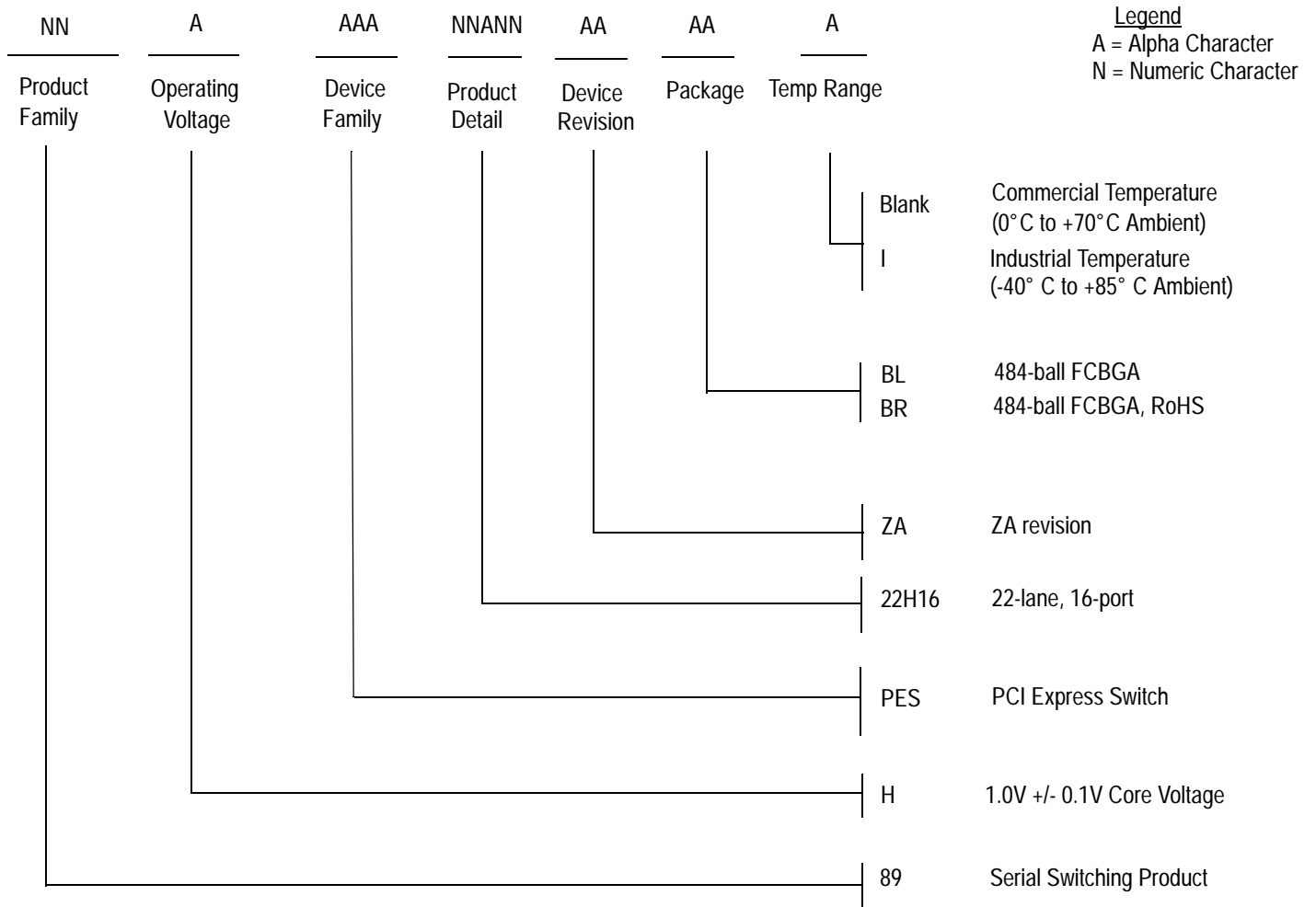
**April 16, 2008:** In Table 16, Thermal Specifications, revised values for  $\theta_{JA}$ ,  $\theta_{JB}$ , and  $\theta_{JC}$ .

**November 17, 2008:** In Table 15, Power Consumption, changed Watts value for typical PCIe Termination Supply from 0.9 to 0.8 and changed Total Typical Power from 5.018 to 4.92.

**October 21, 2009:** Added Industrial temperature to ordering codes on page 36.

**October 3, 2011:** Added new Table 14, PES22H16 Absolute Maximum Voltage Rating.

## Ordering Information



Legend

A = Alpha Character  
N = Numeric Character

### Valid Combinations

- 89HPES22H16ZABL 484-ball FCBGA package, Commercial Temperature
- 89HPES22H16ZABR 484-ball RoHS FCBGA package, Commercial Temperature
- 89HPES22H16ZABLI 484-ball FCBGA package, Industrial Temperature
- 89HPES22H16ZABRI 484-ball RoHS FCBGA package, Industrial Temperature

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